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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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4V Drive Pch+Pch MOSFET

SH8J66

Structure

Silicon P-channel MOSFET

Features

- 1) Low On-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (SOP8).

Applications

Switching

Packaging specifications

	Package	Taping
Type	Code	TB
	Basic ordering unit (pieces)	2500
SH8J66		0

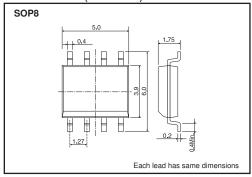
●Absolute maximum ratings (Ta=25°C)

<It is the same ratings for Tr1 and Tr2.>

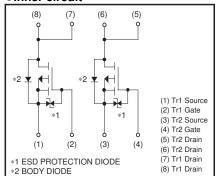
Parameter		Symbol		Limits	Unit
Drain-source voltage		VDSS		-30	V
Gate-source voltage		V _{GSS}		±20	V
Drain current	Continuous	I _D		±9	Α
	Pulsed	I _{DP}	*1	±36	Α
Source current	Continuous	Is		-1.6	Α
(Body diode)	Pulsed	I _{SP}	*1	-36	Α
Total power dissipation		Pp	*2	2.0	W / TOTAL
		Гυ		1.4	W / ELEMENT
Channel temperature		Tch		150	°C
Range of Storage temperature		Tstg		-55 to +150	°C

*1 Pw≤10µs, Duty cycle≤1% *2 Mounted on a ceramic board

●Dimensions (Unit: mm)



●Inner circuit



SH8J66 Data Sheet

●Electrical characteristics (Ta=25°C)

<It is the same characteristics for Tr1 and Tr2.>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	-	_	±10	μА	V _{GS} =±20V, V _{DS} =0V
Drain-source breakdown voltage	V _{(BR) DSS}	-30	_	_	V	I _D = -1mA, V _{GS} =0V
Zero gate voltage drain current	IDSS	-	_	-1	μΑ	V _{DS} = -30V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	-1.0	_	-2.5	V	V _{DS} = -10V, I _D = -1mA
Static drain-source on-state resistance	RDS (on)	-	13.5	18.5	mΩ	ID= -9A, VGS= -10V
		-	17.5	23.6	mΩ	I _D = -4.5A, V _G S= -4.5V
		-	19.0	24.7	mΩ	I _D = -4.5A, V _G S= -4.0V
Forward transfer admittance	Y _{fs} *	11	_	_	S	V _{DS} = -10V, I _D = -9A
Input capacitance	Ciss	1	3000	_	рF	V _{DS} = -10V
Output capacitance	Coss	-	400	_	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	-	400	_	pF	f=1MHz
Turn-on delay time	t _{d (on)} *	-	20	_	ns	V _{DD} ≒ −15V
Rise time	tr *	-	60	_	ns	I _D = -4.5A V _G s= -10V
Turn-off delay time	td (off) *	_	170	_	ns	VGS= -10V RL=3.3Ω
Fall time	t _f *	-	100	_	ns	R _G =10Ω
Total gate charge	Qg *	-	35	_	nC	V _{DD} ≒-15V
Gate-source charge	Qgs *	_	9	_	nC	I _D = -9A V _G s= -5V
Gate-drain charge	Q _{gd} *	_	12	_	nC	$R_L=1.7\Omega / R_G=10\Omega$

^{*}Pulsed

●Body diode characteristics (Source-drain) (Ta=25°C)

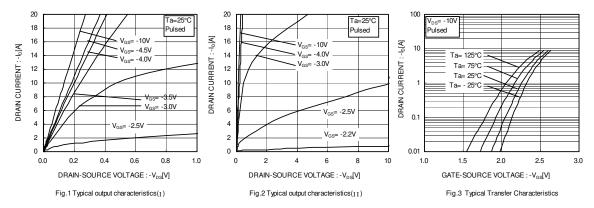
<It is the same characteristics for Tr1 and Tr2.>

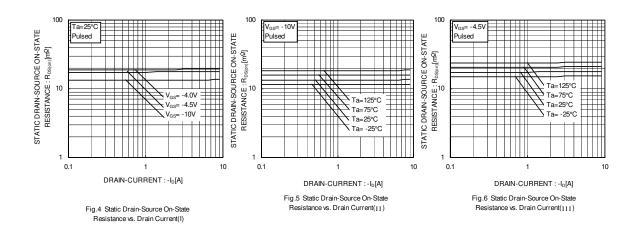
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp*	_	_	-1.2	V	I _S = -9A, V _{GS} =0V

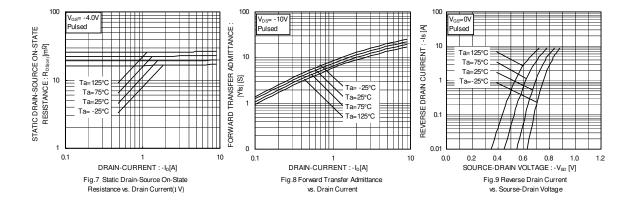
^{*} Pulsed

SH8J66 Data Sheet

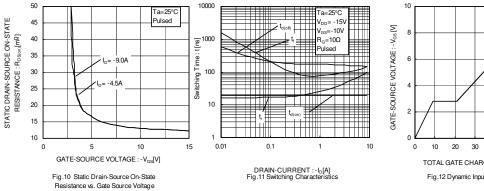
•Electrical characteristic curves

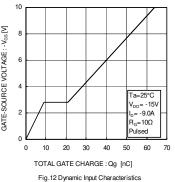


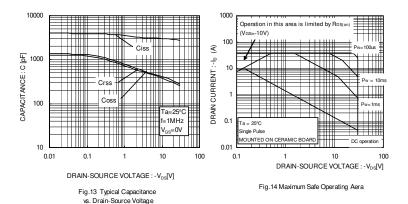




SH8J66 Data Sheet







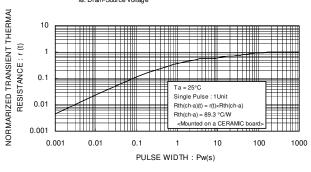


Fig.15 Normalized Transient Thermal Resistance vs. Pulse Width

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● Measurement circuits

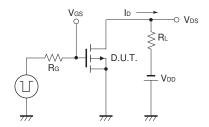


Fig.1-1 Switching Time Test Circuit

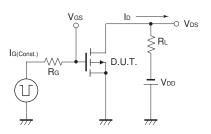


Fig.2-1 Gate Charge Test Circuit

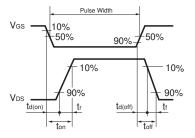


Fig.1-2 Switching Time Waveforms

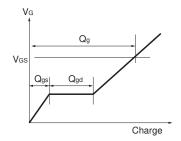


Fig.2-2 Gate Charge Waveform

Notes

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